



N-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a	Q _g (Typ.)		
30	0.0057 at V _{GS} = 10 V	24	13.8 nC		
30	0.0076 at V _{GS} = 4.5 V	21	13.0110		

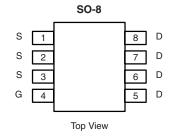
FEATURES

- Halogen-free
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested

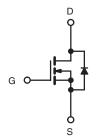


APPLICATIONS

Notebook DC/DC



Ordering Information: Si4168DY-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	IGS T _A = 25 °C,	unless othe	rwise noted	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V_{DS}	30	V	
Gate-Source Voltage	V_{GS}	± 20		
	T _C = 25 °C		24	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		19.4	
Continuous Diain Current (1) = 130 °C)	T _A = 25 °C	l _D	16 ^{b, c}	A
	T _A = 70 °C	°C	14 ^{b, c}	^
Pulsed Drain Current		I _{DM}	70	
Avalanche Current Avalanche Energy L = 0.1 mH		I _{AS}	35	
		E _{AS}	61	mJ
Continuous Source-Drain Diode Current	T _C = 25 °C		4.7	А
Continuous Source-Diam Diode Current	T _A = 25 °C	- I _S	2.1 ^{b, c}	^
	T _C = 25 °C		5.7	
Maximum Power Dissipation	T _C = 70 °C	P _D	3.6	W
Maximum Fower Dissipation	T _A = 25 °C		2.5 ^{b, c}	VV
	T _A = 70 °C		1.6 ^{b, c}	
Operating Junction and Storage Temperatur	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, f}	t ≤ 10 s	R_{thJA}	35	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	18	22	O/ VV		

Notes:

- a. Based on T_C = 25 °C.
 b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			٧	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		27		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		3	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Osto Vallana Busin Ourset		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	40		1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			Α	
Dunin Course On Chata Basistanas	В	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0047	0.0057	0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 18 \text{ A}$		0.0062	0.0076	δ	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		90		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1720			
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		355		pF	
Reverse Transfer Capacitance	C _{rss}			130			
		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		29	44		
Total Gate Charge	Q _g V _{DS} = 10 V, V _{GS} = 10 V, 1 _D = 20 X		13.8	21	nC		
Gate-Source Charge	Q_{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		5.0		nc nc	
Gate-Drain Charge	Q_{gd}			4.6			
Gate Resistance	R_g	f = 1 MHz		1.1	2.2	Ω	
Turn-On Delay Time	t _{d(on)}			25	40		
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		14	25	1	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.0 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		30	45		
Fall Time	t _f			15	25	no	
Turn-On Delay Time	t _{d(on)}			11	20	ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		9	15		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		27	40		
Fall Time	t _f			9	15		
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			4.7	Α	
Pulse Diode Forward Current	I _{SM}				70		
Body Diode Voltage	V_{SD}	$I_S = 4.1 A, V_{GS} = 0 V$		0.75	1.2	٧	
Body Diode Reverse Recovery Time	t _{rr}			25	50	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 4.1 A, dI/dt = 100 A/μs, T _{.1} = 25 °C		17	35	nC	
Reverse Recovery Fall Time	t _a	1 1 = 4.1 Λ, αναι = 100 Ανμο, 1 J = 25 C		13		20	
Reverse Recovery Rise Time t _b				12		ns	

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

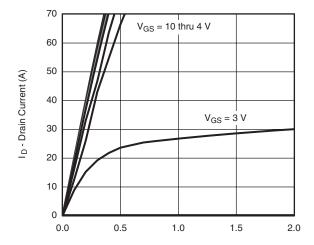
a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$

b. Guaranteed by design, not subject to production testing.



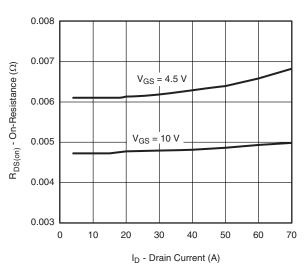


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

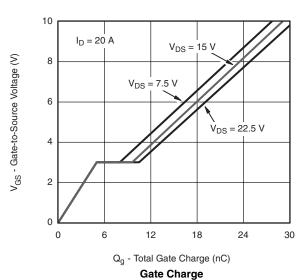


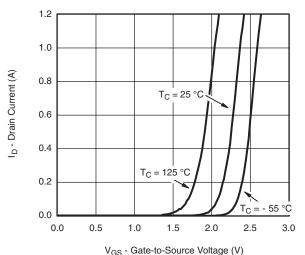
 V_{DS} - Drain-to-Source Voltage (V)

Output Characteristics



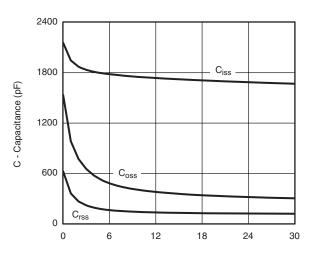
On-Resistance vs. Drain Current and Gate Voltage





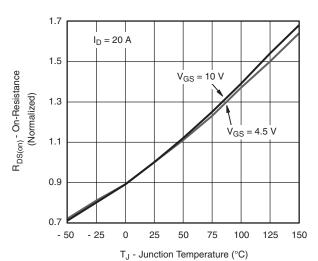
VGS date to bource voltage (V)

Transfer Characteristics



 V_{DS} - Drain-to-Source Voltage (V)

Capacitance

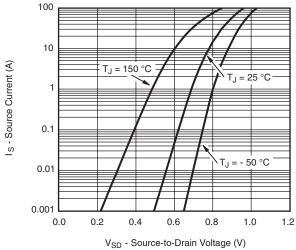


On-Resistance vs. Junction Temperature

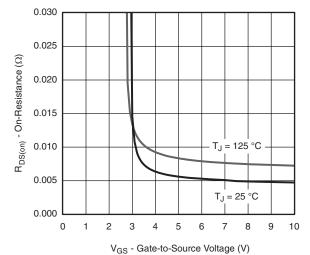
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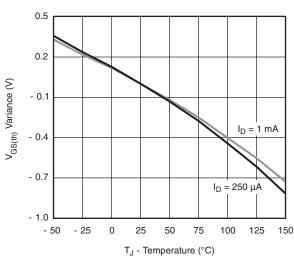
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



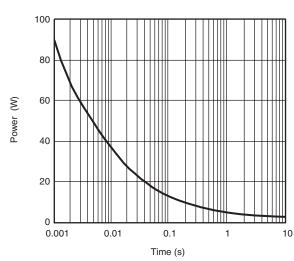
Source-Drain Diode Forward Voltage



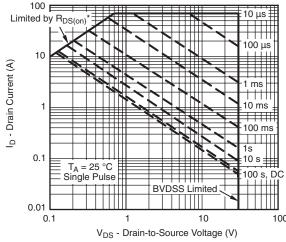
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



Single Pulse Power (Junction-to-Ambient)

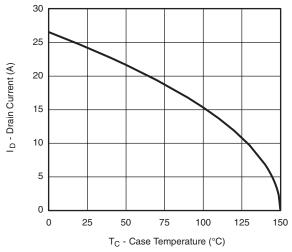


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

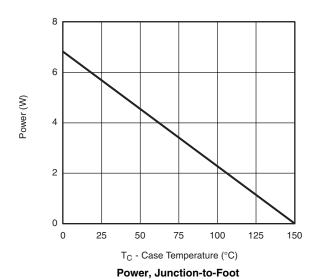
Safe Operating Area, Junction-to-Ambient

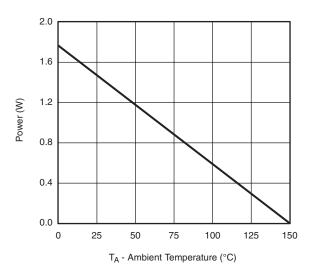


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Current Derating*





Power, Junction-to-Ambient

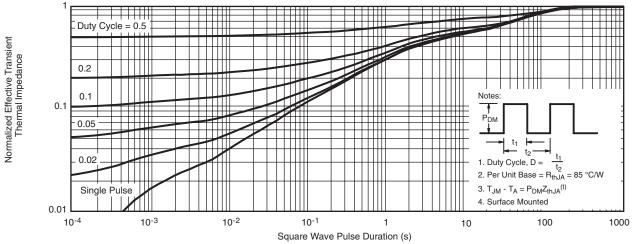
Document Number: 69005 S-82668-Rev. A, 03-Nov-08

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

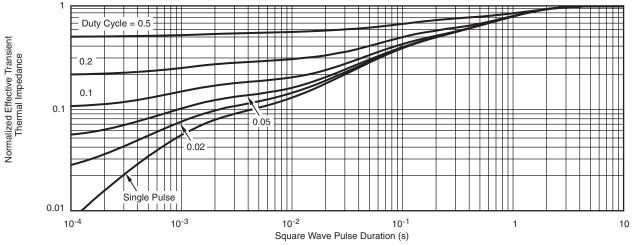
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	INCHES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	0.050 BSC		
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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